



SMD Comm X7R HV, Ceramic, 0.068 uF, 10%, 1,500 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 2225, 3.2 mm



General Information	
Series	SMD Comm X7R HV
Style	SMD Chip
Description	SMD, MLCC, High Voltage, Temperature Stable
Features	High Voltage
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	460 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	2225
L	5.6mm +/-0.4mm
W	6.4mm +/-0.4mm
Т	2.5mm +/-0.20mm
S	3.2mm MIN
В	0.6mm +/-0.35mm

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W	6.4mm +/-0.4mm	٦
Т	2.5mm +/-0.20mm	\
S	3.2mm MIN	E
В	0.6mm +/-0.35mm	7
		1
Packaging Specifications		

Specifications	
Capacitance	0.068 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	1500 VDC
Dielectric Withstanding Voltage	1,800 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0 Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	14.7059 GOhms

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	2000

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